



Product Change Notification

Change Notification #: 116079 - 01

Change Title: Intel® Ethernet SFP+ SR Optics Kit,
Product Code: E10GSFPSRG1P5 MM#909923,
**PCN 116079-01, Product Design,
Multiple Product Design Updates, Label Update
Reason for Revision: Adding Finisar PN and
updates to Description**

Date of Publication: March 06, 2018

Key Characteristics of the Change:

Product Design, Label

Forecasted Key Milestones:

| | |
|---|---------------|
| Date Customer Must be Ready to Receive Post-Conversion Material: | March 9, 2018 |
|---|---------------|

Description of Change to the Customer:

Reason for Revision: Adding Finisar PN and updates to Description

The Intel products listed in the Products Affected table will undergo the following changes:

In order to keep pace with the rapidly growing volume and competitive demand, our Optical Transceiver suppliers have made enhancements to their SFP+ SR optical transceiver solutions through what are considered minor changes.

1. The updated transceiver integrates multiple discrete components within the module into a single IC, while the optical sub-assemblies are migrated from TO-can to Chip-on-flex. The maximum power consumption is reduced ~0.2W.
2. Mechanically, the EMI collar is laser-welded (previously wrap around).
3. The Intel PN on the optic label will be updated from E65689-004 to E65689-006, and the supplier PN will be updated per the table and photos below:

| Current Intel PN | Current Finisar PN on Optic | New Intel PN | New Finisar PN on Optic |
|------------------|-----------------------------|--------------|-------------------------|
| E65689-004 | FTLX8571D3BCVI31 | E65689-006 | FTLX8574D3BCV-I3 |

Current



New



Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers.

The customer can expect to receive mixed inventory.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

| Product Code | MM# | Pre Change TA | Post Change TA |
|---------------|--------|---------------|----------------|
| E10GSFPSRG1P5 | 909923 | G17046-007 | G17046-008 |

PCN Revision History:

Date of Revision:

February 22, 2018

[March 06, 2018](#)

Revision Number:

00

[01](#)

Reason:

Originally Published PCN

[Adding Finisar PN and updates to Description](#)



Product Change Notification

116079 - 01

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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